



ELECTRICAL CHARACTERISTICS:

This filter satisfies Table 1 at Temperature Range: -40 to +85°C

CENTER FREQUENCY :fo=2595 MHz PASSBAND WIDTH :2515~2675 MHz

NPUT/OUTPUT IMPEDANCE :50 Ω

Max. INPUT POWER : 10 W

Moisture Sensitivity Level: 2a

CDR2000

2595 MHz Ceramic Filter

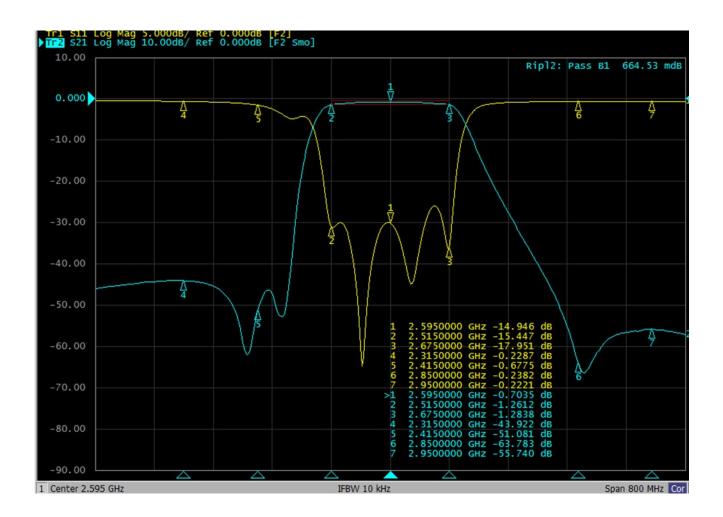
Package Dimensions

15 x 6.4 x 4.4 mm

TABLE 1

NO.	ITEM		SPECIFICATION		
			Min	Max	
1	PASS BAND INSERTION LOSS			1.5 dB	
2	PASS BAND RIPPLE			1.0 dB	
3	PASS BAND RETURN LOSS		10 dB		
4	STOP—BAND ATTENUATION	at 2315~2415 MHz	30 dB		
		at 2850~2950 MHz	40 dB		
Item NO.4 specifies the absolute value of attenuation.					

***Data is measured on the manufacturer's EVB board**



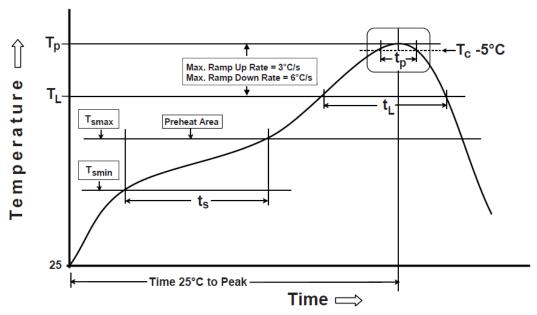
2 Recommended Reflow Soldering Profile

The products can be assembled following Pb-free assembly. According to the Standard IPC/ JEDEC J-STD-020C, the temperature profile suggested is as follow:

Phase	Profile features	Pb-Free Assembly (SnAgCu)	
	-Temperature Min(Tsmin)	150°C	
PREHEAT	-Temperature Max(Tsmax)	200°C	
	-Time(ts) form (Tsmin to Tsmax)	60-120 seconds	
RAMP-UP	Avg. Ramp-up Rate (Tsmax to TP)	3°C/second(max)	
REFLOW	-Temperature(TL)	217°C	
KELLOW	-Total Time above TL (t L)	30-100 seconds	
PEAK	-Temperature(TP)	260°C	
FEAK	-Time(tp)	3 second	
RAMP-DOWN	Rate	6°C / second max.	
Time from 25°C	to Peak Temperature	8 minutes max.	
Composition of s	older paste	96.5Sn/3Ag/0.5Cu	
Solder Paste Mod	lel	SHENMAO PF606-P26	

Note: All the temperature measure point is on top surface of the component, if temperature over recommend, it will make component surface peeling or damage.

The graphic shows temperature profile for component assembly process in reflow ovens



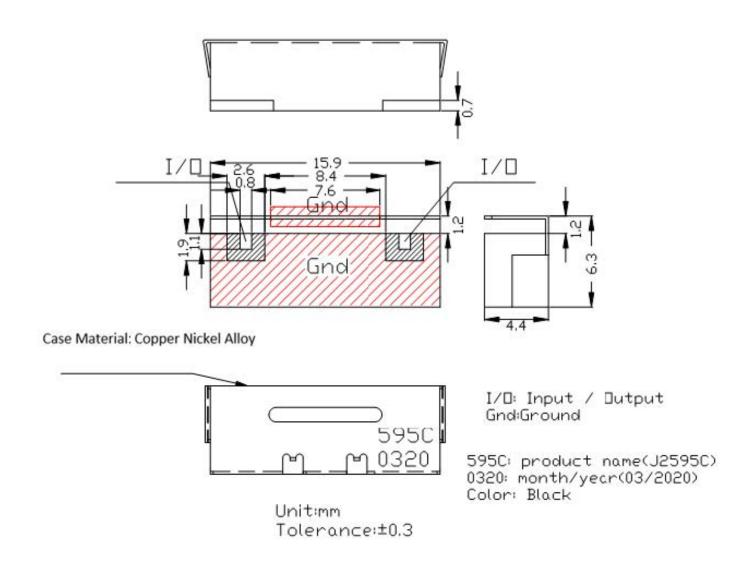
Soldering With Iron:

Soldering condition: Soldering iron temperature 270±10 °C.

Apply preheating at 120°C for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron over temperature 270±10 °C or 3 seconds, it will make component surface peeling or damage. Soldering iron can not leakage of electricity.

3.DIMENSION AND PCB LAYOUT

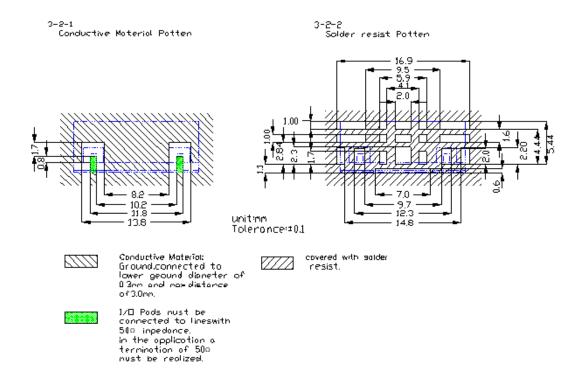
3-1 SHAPE AND DIMENSION



3-2 PCB RECOMMENDED PATTERN FOR FILTER

Note: Test PCB material: FR4 4.6, 1.0mm.

The filter use limit: the layout goes away PCB edge.





- 1. The design, manufacturing process, and specifications of this device are subject to change. 2. US or International patents may apply.
- 3. RoHS compliant from the first date of manufacture.